**会TDK** 

# Chip Beads(SMD Array) For General Signal Line

# MZA Series MZA1210 Type

#### FEATURES

- · A single MZA series chip provides noise attenuation for two lines, making it ideal for use with I/O lines of various highly miniaturized.
- · Electronic equipment, such as portable products, which comprise high density circuitry.
- · Low crosstalk between adjacent circuits.
- · Internal electrodes feature low DC resistance, minimizing wasteful power consumption.
- · Electroplated terminal electrodes accommodate reflow soldering.
- · Monolithic structure ensures high reliability.
- · The products contain no lead and also support lead-free soldering
- · It is a product conforming to RoHS directive.

#### APPLICATIONS

Removal of signal line noises of cellular phones, PCs, note PCs, TVs, DVDs, DSCs, game machines, digital photo frames, PNDs, etc.

#### **PRODUCT IDENTIFICATION**

MZA	1210	D	121	С	Т
(1)	(2)	(3)	(4)	(5)	(6)

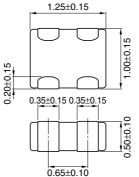
- (1) Series name
- (2) Dimensions L×W
- (3) Material code
- (4) Nominal impedance 121:120Ω at 100MHz
- (5) Characteristic type
- (6) Packaging style

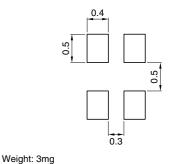
T:Taping

#### HANDLING AND PRECAUTIONS

- · Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- · After mounting components onto the printed circuit board, do not apply stress through board bending or mishandling.
- Do not expose the inductors to stray magnetic fields.
- · Avoid static electricity discharge during handling.
- · When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.
- · This product does not apply to flow soldering construction method.

### SHAPES AND DIMENSIONS/RECOMMENDED PC BOARD PATTERN





Dimensions in mm

#### **CIRCUIT DIAGRAM**



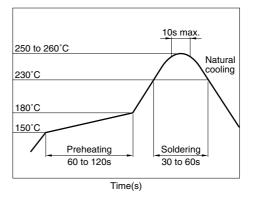


# **TEMPERATURE RANGES**

Operating/storage	–55 to +125°C

Packaging style	Quantity
Taping	5000 pieces/reel

#### **RECOMMENDED SOLDERING CONDITION REFLOW SOLDERING**



- · Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application are considered the following: The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

#### · All specifications are subject to change without notice.

#### **ELECTRICAL CHARACTERISTICS**

Part No.	Impedance(Ω) ±25%[100MHz]*	DC resistance (Ω)max.	Rated current (mA)max.	Rated voltage (V)max.
MZA1210D330C	33	0.3	50	5
MZA1210D680C	68	0.5	50	5
MZA1210D121C	120	0.8	50	5
MZA1210D241C	240	1.2	50	5

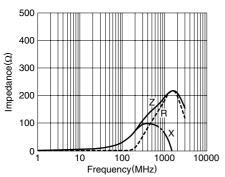
\* Test equipment: E4991A or equivalent

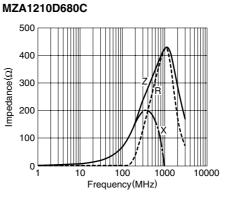
Test tool: 16192A or equivalent

Test temperature: 25±10°C

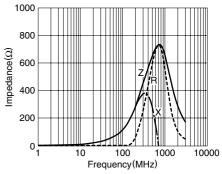
# TYPICAL ELECTRICAL CHARACTERISTICS Z, X, R vs. FREQUENCY CHARACTERISTICS

## MZA1210D330C

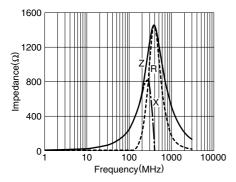




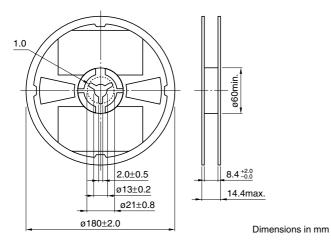
## MZA1210D121C



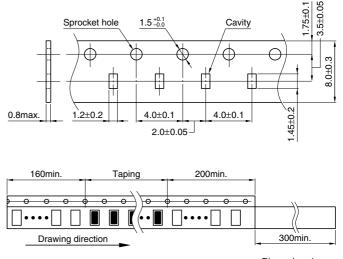
### MZA1210D241C



PACKAGING STYLES REEL DIMENSIONS



#### TAPE DIMENSIONS



Dimensions in mm

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